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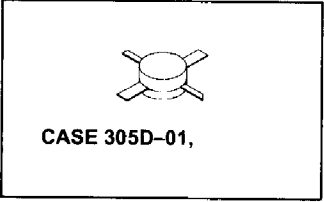
The RF Line
NPN Silicon
RF Power Transistor

Designed for 24 Volt UHF large-signal, common emitter, class A linear amplifier applications in industrial and commercial equipment operating in the range of 800–960 MHz.

- Specified for $V_{CE} = 24$ Vdc, $I_C = 0.3$ Adc Characteristics
 Output Power = 2.1 Watts CW
 Minimum Power Gain = 12.5 dB
 Minimum ITO = +43 dBm
 Typical Noise Figure = 5.25 dB
- Characterized with Small-Signal S-Parameters and Series Equivalent Large-Signal Parameters from 800–960 MHz
- Silicon Nitride Passivated
- 100% Tested for Load Mismatch Stress at All Phase Angles with 30:1 VSWR @ 24 Vdc, $I_C = 0.3$ Adc and Rated Output Power
- Will Withstand RF Input Overdrive of 0.4 W CW
- Gold Metallized, Emitter Ballasted for Long Life and Resistance to Metal Migration
- Circuit board photomaster available upon request by contacting RF Tactical Marketing in Phoenix, AZ.



CLASS A
800–960 MHz
2.1 W (CW), 24 V
NPN SILICON
RF POWER TRANSISTOR



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	30	Vdc
Collector–Base Voltage	V_{CBO}	55	Vdc
Emitter–Base Voltage	V_{EBO}	4	Vdc
Total Device Dissipation @ $T_C = 50^\circ\text{C}$ Derate above 50°C	P_D	17 0.114	Watts W/ $^\circ\text{C}$
Operating Junction Temperature	T_J	200	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	–65 to +150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance ($T_J = 150^\circ\text{C}$, $T_C = 50^\circ\text{C}$)	$R_{\theta JC}$	8.4	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector–Emitter Breakdown Voltage ($I_C = 20$ mA, $I_B = 0$)	$V_{(BR)CEO}$	28	35	—	Vdc
Collector–Emitter Breakdown Voltage ($I_C = 20$ mA, $V_{BE} = 0$)	$V_{(BR)CES}$	55	85	—	Vdc
Collector–Base Breakdown Voltage ($I_C = 20$ mA, $I_E = 0$)	$V_{(BR)CBO}$	55	85	—	Vdc
Emitter–Base Breakdown Voltage ($I_E = 1$ mA, $I_C = 0$)	$V_{(BR)EBO}$	4	5	—	Vdc
Collector Cutoff Current ($V_{CB} = 24$ V, $I_E = 0$)	I_{CES}	—	—	1	mA

(continued)

NJ Semi-Conductors reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by NJ Semi-Conductors is believed to be both accurate and reliable at the time of going to press. However, NJ Semi-Conductors assumes no responsibility for any errors or omissions discovered in its use. NJ Semi-Conductors encourages customers to verify that datasheets are current before placing orders.



ELECTRICAL CHARACTERISTICS — continued

Characteristic	Symbol	Min	Typ	Max	Unit
ON CHARACTERISTICS					
DC Current Gain ($I_C = 0.1 \text{ A}$, $V_{CE} = 5 \text{ V}$)	h_{FE}	30	60	120	—
DYNAMIC CHARACTERISTICS					
Output Capacitance ($V_{CB} = 24 \text{ V}$, $f = 1 \text{ MHz}$)	C_{ob}	2.4	3.3	4.4	pF
FUNCTIONAL CHARACTERISTICS					
Common-Emitter Power Gain ($V_{CE} = 24 \text{ V}$, $I_C = 0.3 \text{ A}$, $f = 840\text{--}900 \text{ MHz}$, Power Output = 2.1 W)	P_g	12.5	13.5	—	dB
Load Mismatch ($P_o = 2.1 \text{ W}$) ($V_{CE} = 24 \text{ V}$, $I_C = 0.3 \text{ A}$, $f = 840 \text{ MHz}$, Load VSWR = 30:1, All Phase Angles)	ψ	No Degradation in Output Power			
RF Input Overdrive ($V_{CE} = 24 \text{ V}$, $I_C = 0.3 \text{ A}$, $f = 840 \text{ MHz}$) No degradation	$P_{in(over)}$	—	—	0.4	W
Third Order Intercept Point ($V_{CE} = 24 \text{ V}$, $I_C = 0.3 \text{ A}$) ($f_1 = 900 \text{ MHz}$, $f_2 = 900.1 \text{ MHz}$, Meas. @ IMD 3rd Order = -40 dBc)	ITO	+43	+44.5	—	dBm
Noise Figure ($V_{CE} = 24 \text{ V}$, $I_C = 0.3 \text{ A}$, $f = 900 \text{ MHz}$)	NF	—	5.25	—	dB
Input Return Loss ($V_{CE} = 24 \text{ V}$, $I_C = 0.3 \text{ A}$, $f = 840\text{--}900 \text{ MHz}$, Power Output = 2.1 W)	IRL	—	-15	-10	dB

Table 1. MRF857S Common Emitter S-Parameters

V_{CE} (V)	I_C (A)	f (MHz)	S11		S21		S12		S22	
			S11	$\angle \phi$	S21	$\angle \phi$	S12	$\angle \phi$	S22	$\angle \phi$
24	0.3	800	0.915	165	2.098	54	0.037	58	0.343	-157
		820	0.915	165	2.049	53	0.038	58	0.345	-157
		840	0.915	165	1.991	52	0.038	58	0.349	-157
		860	0.913	164	1.951	51	0.039	59	0.352	-158
		880	0.914	164	1.912	50	0.040	59	0.355	-158
		900	0.914	163	1.865	49	0.041	59	0.359	-158
		920	0.913	163	1.832	48	0.042	59	0.362	-158
		940	0.915	162	1.783	47	0.043	59	0.366	-159
		960	0.916	162	1.748	46	0.043	59	0.369	-159

Table 2. Z_{in} and Z_{OL}^* versus Frequency

f (MHz)	Z_{in} (Ohms)		Z_{OL}^* (Ohms)	
840	1.5	4.4	18.4	-26.3
870	1.7	4.7	18.0	-26.1
900	1.5	4.8	14.9	-26.2

$V_{CE} = 24 \text{ V}$, $I_C = 0.3 \text{ A}$, $P_o = 2.1 \text{ W}$

Z_{OL}^* = Conjugate of optimum load impedance into which the device operates at a given output power, voltage and frequency.